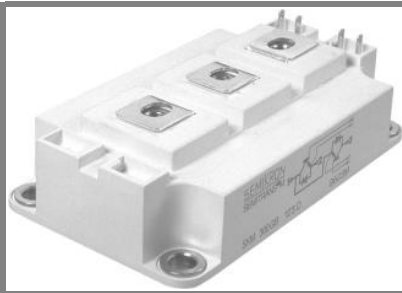


# SKM 600GB126D ...



**SEMITRANS® 3**

## Trench IGBT Module

**SKM 600GB126D**

**SKM 600GAL126D**

Preliminary Data

### Features

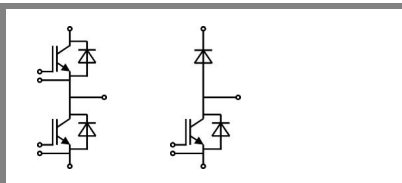
- Trench = Trenchgate technology
- $V_{CEsat}$  with positive temperature coefficient
- High short circuit capability, self limiting to  $6 \times I_C$

### Typical Applications

- AC inverter drives
- UPS
- Electronic welders

### Remarks

- $I_{DC} \leq 500A$  for  $T_{Terminal} = 100^\circ C$

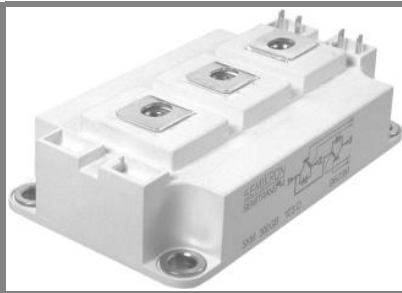


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Absolute Maximum Ratings		$T_c = 25^\circ C$ , unless otherwise specified		
Symbol	Conditions	Values		Units
<b>IGBT</b>				
$V_{CES}$	$T_j = 25^\circ C$	1200		V
$I_C$	$T_j = 150^\circ C$	$T_c = 25^\circ C$	660	A
		$T_c = 80^\circ C$	460	A
$I_{CRM}$	$I_{CRM} = 2 \times I_{Cnom}$	800		A
$V_{GES}$		$\pm 20$		V
$t_{psc}$	$V_{CC} = 600 V; V_{GE} \leq 20 V; T_j = 125^\circ C$ $V_{CES} < 1200 V$	10		$\mu s$
<b>Inverse Diode</b>				
$I_F$	$T_j = 150^\circ C$	$T_c = 25^\circ C$	490	A
		$T_c = 80^\circ C$	340	A
$I_{FRM}$	$I_{FRM} = 2 \times I_{Fnom}$	800		A
$I_{FSM}$	$t_p = 10 ms; sin.$	$T_j = 150^\circ C$	2880	A
<b>Freewheeling Diode</b>				
$I_F$	$T_j = 150^\circ C$	$T_c = 25^\circ C$	490	A
		$T_c = 80^\circ C$	340	A
$I_{FRM}$	$I_{FRM} = 2 \times I_{Fnom}$	800		A
$I_{FSM}$	$t_p = 10 ms; sin.$	$T_j = 150^\circ C$	2880	A
<b>Module</b>				
$I_{t(RMS)}$		500		A
$T_{vj}$		- 40 ... + 150		$^\circ C$
$T_{stg}$		- 40 ... + 125		$^\circ C$
$V_{isol}$	AC, 1 min.	4000		V

Characteristics		$T_c = 25^\circ C$ , unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
<b>IGBT</b>					
$V_{GE(th)}$	$V_{GE} = V_{CE}, I_C = 16 mA$	5	5,8	6,5	V
$I_{CES}$	$V_{GE} = 0 V, V_{CE} = V_{CES}$	$T_j = 25^\circ C$	0,2	0,6	mA
		$T_j = 125^\circ C$			mA
$V_{CE0}$		$T_j = 25^\circ C$	1	1,2	V
		$T_j = 125^\circ C$	0,9	1,1	V
$r_{CE}$	$V_{GE} = 15 V$	$T_j = 25^\circ C$	1,8	2,4	$m\Omega$
		$T_j = 125^\circ C$	2,8	3,4	$m\Omega$
$V_{CE(sat)}$	$I_{Cnom} = 400 A, V_{GE} = 15 V$	$T_j = 25^\circ C_{chiplev.}$	1,7	2,15	V
		$T_j = 125^\circ C_{chiplev.}$	2	2,45	V
$C_{ies}$	$V_{CE} = 25, V_{GE} = 0 V$	$f = 1 MHz$	32		nF
$C_{oes}$			11		nF
$C_{res}$			2,2		nF
$Q_G$	$V_{GE} = -8V - +20V$	3600		nC	
$R_{Gint}$	$T_j = ^\circ C$	1,88		$\Omega$	
$t_{d(on)}$	$R_{Gon} = 2 \Omega$	$V_{CC} = 600V$	290		ns
			$I_C = 400A$	60	
$t_r$	$R_{Goff} = 2 \Omega$	$T_j = 125^\circ C$	39		mJ
$E_{on}$			670		ns
$t_{d(off)}$	$V_{GE} = \pm 15V$	80		ns	
$t_f$		64		mJ	
$E_{off}$					
$R_{th(j-c)}$	per IGBT	0,055		K/W	



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## Trench IGBT Module

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**SKM 600GAL126D**

Preliminary Data

### Features

- Trench = Trenchgate technology
- $V_{CEsat}$  with positive temperature coefficient
- High short circuit capability, self limiting to  $6 \times I_C$

### Typical Applications

- AC inverter drives
- UPS
- Electronic welders

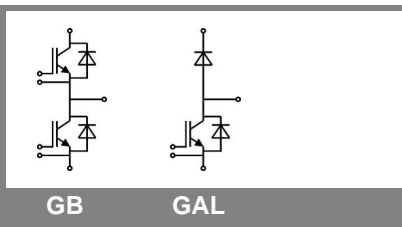
### Remarks

- $I_{DC} \leq 500A$  for  $T_{Terminal} = 100\text{ °C}$

Characteristics					
Symbol	Conditions	min.	typ.	max.	Units
<b>Inverse diode</b>					
$V_F = V_{EC}$	$I_{Fnom} = 400\text{ A}; V_{GE} = 0\text{ V}$	$T_j = 25\text{ °C}_{chiplev.}$	1,6	1,8	V
		$T_j = 125\text{ °C}_{chiplev.}$	1,6	1,8	V
$V_{F0}$		$T_j = 25\text{ °C}$	1	1,1	V
		$T_j = 125\text{ °C}$	0,8	0,9	V
$r_F$		$T_j = 25\text{ °C}$	1,5	1,8	mΩ
		$T_j = 125\text{ °C}$	2	2,3	mΩ
$I_{RRM}$	$I_F = 400\text{ A}$	$T_j = 125\text{ °C}$	475		A
$Q_{rr}$	$di/dt = 7600\text{ A}/\mu\text{s}$		96		μC
$E_{tr}$	$V_{GE} = -15\text{ V}; V_{CC} = 600\text{ V}$		41		mJ
$R_{th(j-c)D}$	per diode			0,125	K/W
<b>Freewheeling Diode</b>					
$V_F = V_{EC}$	$I_{Fnom} = 400\text{ A}; V_{GE} = 0\text{ V}$	$T_j = 25\text{ °C}_{chiplev.}$	1,6	1,8	V
		$T_j = 125\text{ °C}_{chiplev.}$	1,6	1,8	V
$V_{F0}$		$T_j = 25\text{ °C}$	1	1,1	V
		$T_j = 125\text{ °C}$	0,8	0,9	V
$r_F$		$T_j = 25\text{ °C}$	1,5	1,8	V
		$T_j = 125\text{ °C}$	2	2,3	V
$I_{RRM}$	$I_F = 400\text{ A}$	$T_j = 125\text{ °C}$	475		A
$Q_{rr}$	$di/dt = 7600\text{ A}/\mu\text{s}$		96		μC
$E_{tr}$	$V_{GE} = -15\text{ V}; V_{CC} = 600\text{ V}$		41		mJ
$R_{th(j-c)FD}$	per diode			0,125	K/W
<b>Module</b>					
$L_{CE}$			15	20	nH
$R_{CC'+EE'}$	res., terminal-chip	$T_{case} = 25\text{ °C}$	0,35		mΩ
		$T_{case} = 125\text{ °C}$	0,5		mΩ
$R_{th(c-s)}$	per module			0,038	K/W
$M_s$	to heat sink M6		3	5	Nm
$M_t$	to terminals M6		2,5	5	Nm
w				325	g

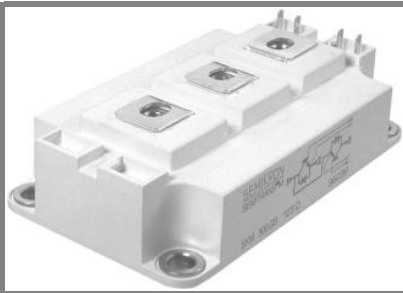
This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

This technical information specifies semiconductor devices but promises no characteristics. No warranty or guarantee expressed or implied is made regarding delivery, performance or suitability.



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## Trench IGBT Module

**SKM 600GB126D**

**SKM 600GAL126D**

Preliminary Data

### Features

- Trench = Trenchgate technology
- $V_{CEsat}$  with positive temperature coefficient
- High short circuit capability, self limiting to  $6 \times I_C$

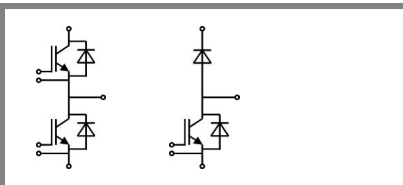
### Typical Applications

- AC inverter drives
- UPS
- Electronic welders

### Remarks

- $I_{DC} \leq 500A$  for  $T_{Terminal} = 100\text{ °C}$

$Z_{th}$		Values	Units
Symbol	Conditions		
$Z_{th(j-c)I}$			
$R_i$	$i = 1$	38	mk/W
$R_i$	$i = 2$	13	mk/W
$R_i$	$i = 3$	3,4	mk/W
$R_i$	$i = 4$	0,6	mk/W
$\tau_{u_i}$	$i = 1$	0,0836	s
$\tau_{u_i}$	$i = 2$	0,009	s
$\tau_{u_i}$	$i = 3$	0,0024	s
$\tau_{u_i}$	$i = 4$	0,0002	s
$Z_{th(j-c)D}$			
$R_i$	$i = 1$	75	mk/W
$R_i$	$i = 2$	39	mk/W
$R_i$	$i = 3$	9,5	mk/W
$R_i$	$i = 4$	1,5	mk/W
$\tau_{u_i}$	$i = 1$	0,0327	s
$\tau_{u_i}$	$i = 2$	0,0101	s
$\tau_{u_i}$	$i = 3$	0,002	s
$\tau_{u_i}$	$i = 4$	0,0003	s



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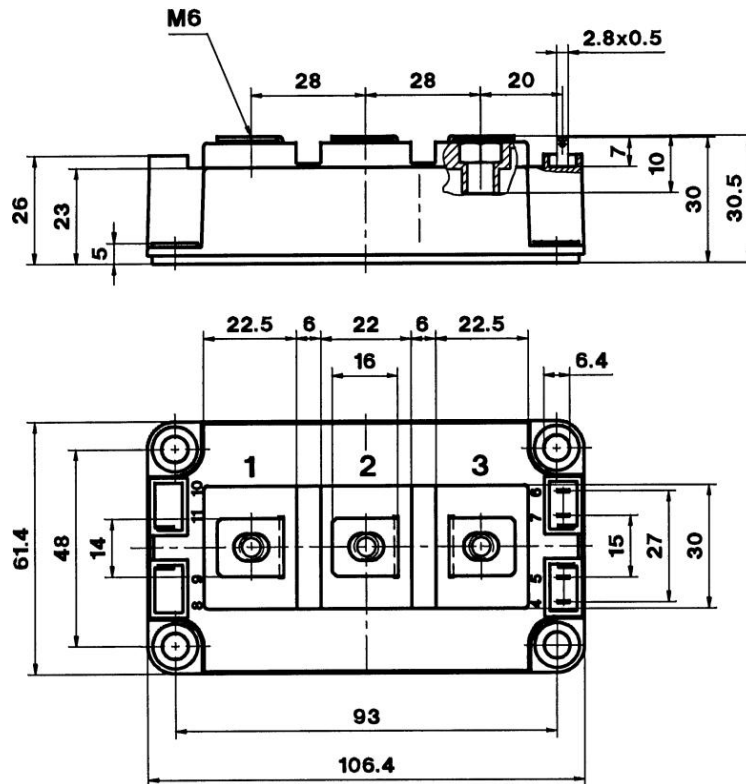
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UL Recognized

CASED56

File no. E 63 532



Case D 56

